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High-Speed Dual-Differential Comparator/Sense Amp

Features

- TTL-Compatible Strobes and Outputs
- Large Common-Mode Input Voltage Range
- Operates from Standard Supply Voltages
- Pb–Free Packages are Available

Applications

- MOS Memory Sense Amp
- A-to-D Conversion
- High-Speed Line Receiver

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage Positive Negative	V+ V-	+7.0 -7.0	V
Differential Input Voltage	V _{IDR}	±6.0	V
Input Voltage Common Mode Strobe/Gate	V _{IN}	±5.0 +5.25	V
Maximum Power Dissipation (Note 1) T _A = 25°C (Still–Air) N Package D Package	P _D	1420 1040	mW
Thermal Resistance, Junction-to-Ambient N Package D Package	$R_{\theta JA}$	100 145	°C/W
Operating Temperature Range	T _A	0 to 70	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Junction Temperature	TJ	150	°C
Lead Soldering Temperature (10 sec max)	T _{sld}	+230	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Derate above 25°C at the following rates:

N package at 10 mW/°C

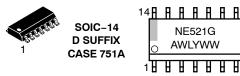
D package at 6.9 mW/°C.

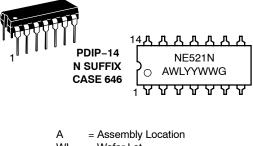


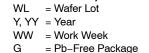
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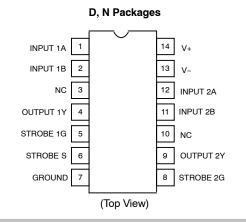
MARKING DIAGRAMS







PIN CONNECTIONS

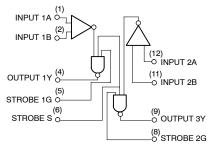


ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

LOGIC FUNCTION TABLE

V _{ID} (A ⁺ , B)	Strobe S	Strobe G	Output (Y)
$V_{ID} \leq -V_{OS}$	Н	Н	L
$-V_{OS} < V_{ID} < V_{OS}$	Н	Н	Undefined
$V_{ID} \ge V_{OS}$	Н	Н	Н
Х	L	Х	Н
Х	Х	L	Н





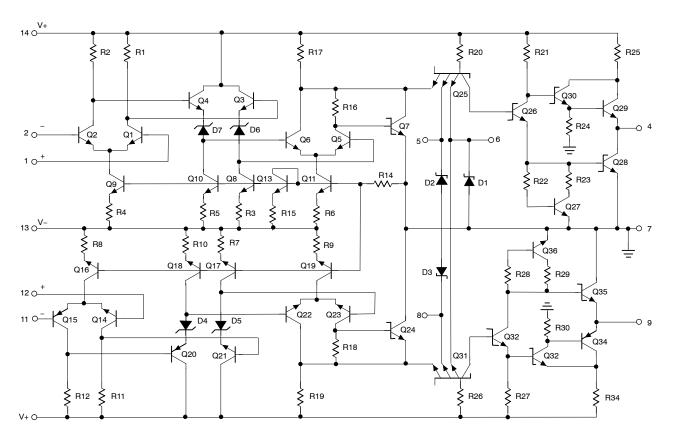


Figure 2. Equivalent Schematic

				Limits		
Characteristic	Test Conditions	Symbol	Min	Тур	Max	Unit
Input Offset Voltage At 25°C Overtemperature Range	V+ = +4.75 V; V- = -4.75 V	V _{OS}		6.0 _	7.5 10	mV
Input Bias Current At 25°C Overtemperature Range	V+ = +5.25 V; V- = -5.25 V			7.5	20 40	μA
Input Offset Current At 25°C Overtemperature Range	V+ = +5.25 V; V- = -5.25 V	l _{os}		1.0	5.0 12	μΑ
Common-Mode Voltage Range	V+ = +4.75 V; V- = -4.75 V	V _{CM}	-3.0	_	+3.0	V
Input Current High	V+ = +5.25 V; V- = -5.25 V V _{IH} = 2.7 V 1G or 2G Strobe Common Strobe S	IIH			50 100	μΑ
Input Current Low	V _{IL} = 0.5 V 1G or 2G Strobe Common Strobe S				-2.0 -4.0	mA
Output Voltage High Low	$V_{I(S)} = 2.0 V$ $V_{+} = +4.75 V; V_{-} = -4.75 V;$ $I_{LOAD} = -1.0 mA$ $V_{+} = +5.25 V; V_{-} = -5.25 V;$ $I_{LOAD} = 20 mA$	V _{OH} V _{OL}	2.7	3.4	0.5	V
Supply Voltage Positive Negative	-	V+ V-	4.75 -4.75	5.0 -5.0	5.25 -5.25	V
Supply Current Positive Negative	V+ = +5.25 V; V- = -5.25 V; $T_A = 25^{\circ}C$	I _{CC+}		27 -15	35 -28	mA
Short-Circuit Output Current	_	I _{SC}	-40	-	-100	mA

DC ELECTRICAL CHARACTERISTICS (V+ = +5.0 V; V- = -5.0 V, T_A = 0°C to +70°C, unless otherwise noted.)

AC ELECTRICAL CHARACTERISTICS (T_A = 25°C; R_L = 280 Ω ; C_L = 15 pF, V+ = 5.0 V; V- = 5.0 V, guaranteed by characterization)

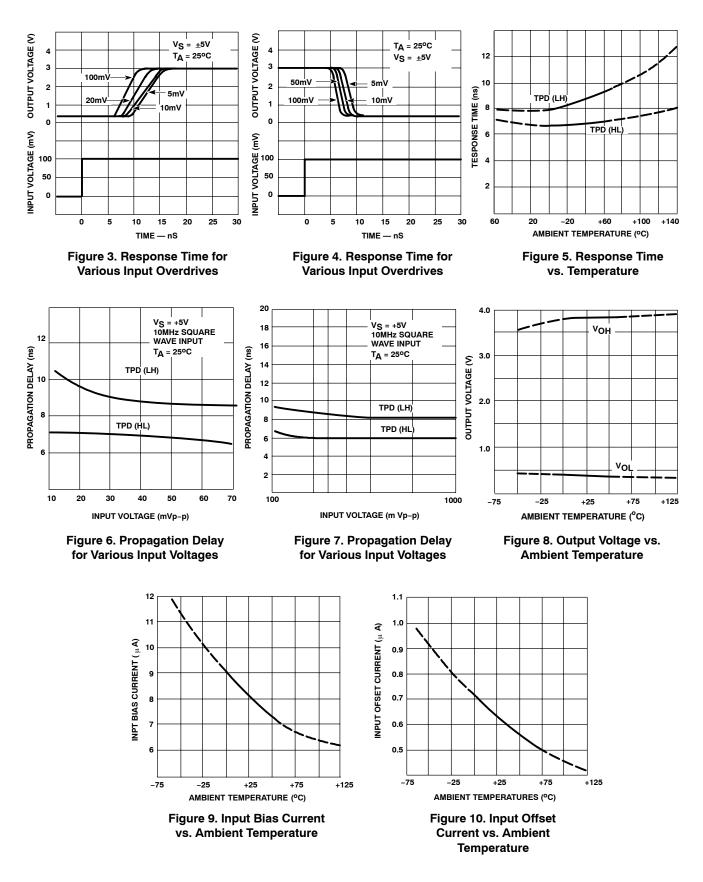
				Limits			
Characteristic	From Input	To Output	Symbol	Min	Тур	Max	Unit

Large-Signal Switching Speed

Propagation Delay							ns
Low to High (Note 2)	Amp	Output	t _{PLH(D)}	-	9.6	12	
High to Low (Note 2)	Amp	Output	t _{PHL(D)}	-	8.2	9.0	
Low to High (Note 3)	Strobe	Output	t _{PLH(S)}	-	4.8	10	
High to Low (Note 3)	Strobe	Output	t _{PHL(S)}	-	3.9	6.0	
Max. Operating Frequency	-	-	f _{MAX}	40	55	-	MHz

2. Response time measured from 0 V point of $\pm 100 \text{ mV}_{P-P}$ 10 MHz square wave to the 1.5 V point of the output. 3. Response time measured from 1.5 V point of input to 1.5 V point of the output.

TYPICAL PERFORMANCE CHARACTERISTICS



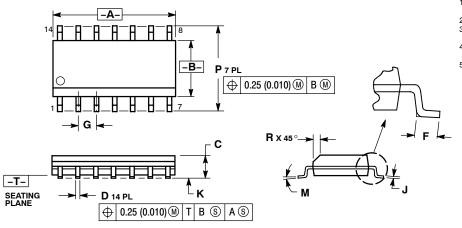
ORDERING INFORMATION

Device	Temperature Range	Package	Shipping [†]
NE521D		SOIC-14	
NE521DG		SOIC-14 (Pb-Free)	55 Units/Rail
NE521DR2	-	SOIC-14	
NE521DR2G	0 to +70°C	SOIC-14 (Pb-Free)	2500/Tape & Reel
NE521N		PDIP-14	
NE521NG		PDIP-14 (Pb-Free)	25 Units/Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOIC-14 CASE 751A-03 **ISSUE H**



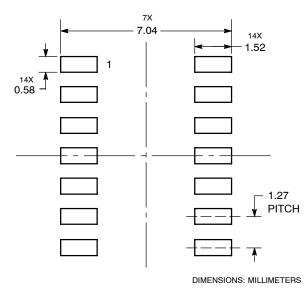
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION: ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.55	8.75	0.337	0.344
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
М	0 °	7 °	0 °	7 °
Р	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

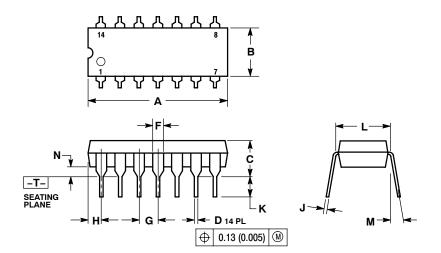
SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

PDIP-14 CASE 646-06 ISSUE P



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

З.

- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 4 ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.715	0.770	18.16	19.56
В	0.240	0.260	6.10	6.60
С	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100	BSC	2.54 BSC	
н	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
М		10 °		10 °
Ν	0.015	0.039	0.38	1.01

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